

Driver Transistors

PNP Silicon

MMBTA55L Series, MMBTA56L Series, SMMBTA56L Series

Features

- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|------------------|------------|------|
| Collector - Emitter Voltage MMBTA55 MMBTA56, SMMBTA56 | V _{CEO} | -60 -80 | Vdc |
| Collector - Base Voltage MMBTA55 MMBTA56, SMMBTA56 | V _{CBO} | -60 -80 | Vdc |
| Emitter - Base Voltage | V _{EBO} | -4.0 | Vdc |
| Collector Current - Continuous | Ic | -500 | mAdc |

THERMAL CHARACTERISTICS

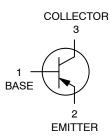
| Characteristic | Symbol | Max | Unit |
|--|-----------------------------------|-------------|-------------|
| Total Device Dissipation FR-5 Board (Note 1) T _A = 25°C Derate above 25°C | P _D | 225 1.8 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 556 | °C/W |
| Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C | P _D | 300 2.4 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 417 | °C/W |
| Junction and Storage Temperature | T _J , T _{stg} | -55 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. FR-5 = $1.0 \times 0.75 \times 0.062$ in.
- 2. Alumina = 0.4 \times 0.3 \times 0.024 in. 99.5% alumina.



SOT-23 CASE 318 STYLE 6



MARKING DIAGRAM



2xx = Device Code

x = H for MMBTA55LT1G xx = GM for MMBTA56LT1G, SMMBTA56LT1G

M = Date Code*

■ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

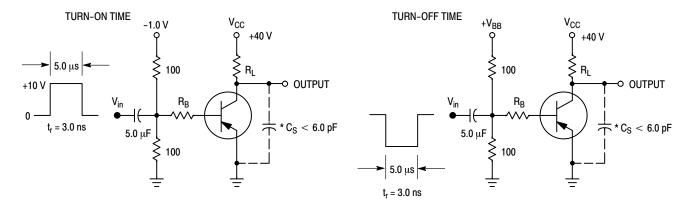
See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|--|-----------------------|------------|--------------|------|
| OFF CHARACTERISTICS | | | | |
| Collector – Emitter Breakdown Voltage (Note 3) (I _C = -1.0 mAdc, I _B = 0) MMBTA55 MMBTA56, SMMBTA56 | V _(BR) CEO | -60 -80 | - - | Vdc |
| Emitter – Base Breakdown Voltage ($I_E = -100 \mu Adc, I_C = 0$) | V _{(BR)EBO} | -4.0 | _ | Vdc |
| Collector Cutoff Current (V _{CE} = -60 Vdc, I _B = 0) | I _{CES} | - | -0.1 | μAdc |
| Collector Cutoff Current $(V_{CB} = -60 \text{ Vdc}, I_E = 0)$ MMBTA55 $(V_{CB} = -80 \text{ Vdc}, I_E = 0)$ MMBTA56, SMMBTA56 | Ісво | - | -0.1 -0.1 | μAdc |
| ON CHARACTERISTICS | | | | |
| DC Current Gain | h _{FE} | 100 100 | _ _ | _ |
| Collector – Emitter Saturation Voltage ($I_C = -100 \text{ mAdc}$, $I_B = -10 \text{ mAdc}$) | V _{CE(sat)} | - | -0.25 | Vdc |
| Base – Emitter On Voltage (I _C = -100 mAdc, V _{CE} = -1.0 Vdc) | V _{BE(on)} | _ | -1.2 | Vdc |
| SMALL-SIGNAL CHARACTERISTICS | | | | |
| Current – Gain – Bandwidth Product (Note 4) (I _C = -100 mAdc, V _{CE} = -1.0 Vdc, f = 100 MHz) | f⊤ | 50 | _ | MHz |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{4.} f_T is defined as the frequency at which $|h_{fe}|$ extrapolates to unity.



^{*}Total Shunt Capacitance of Test Jig and Connectors For PNP Test Circuits, Reverse All Voltage Polarities

Figure 1. Switching Time Test Circuits

^{3.} Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

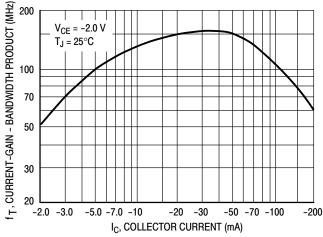


Figure 2. Current-Gain — Bandwidth Product

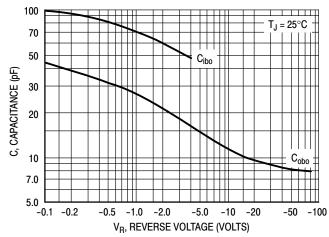


Figure 3. Capacitance

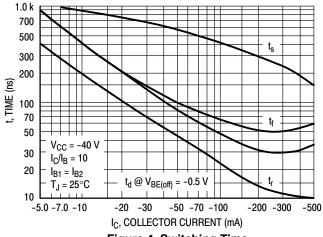


Figure 4. Switching Time

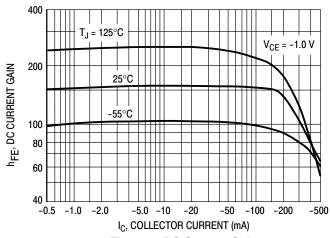
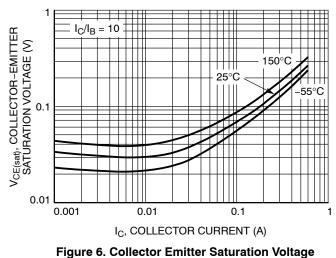


Figure 5. DC Current Gain



vs. Collector Current

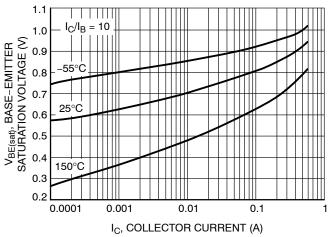


Figure 7. Base Emitter Saturation Voltage vs.
Collector Current

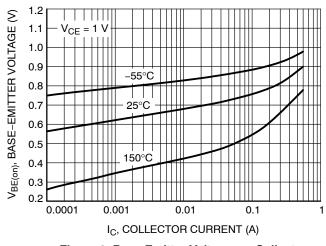


Figure 8. Base Emitter Voltage vs. Collector Current

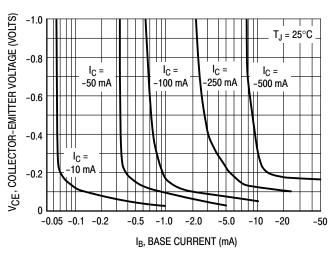


Figure 9. Collector Saturation Region

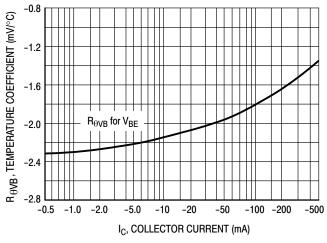


Figure 10. Base–Emitter Temperature Coefficient

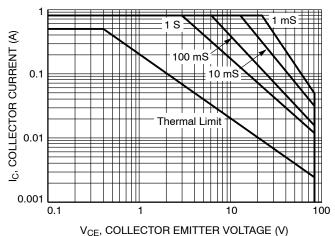


Figure 11. Safe Operating Area

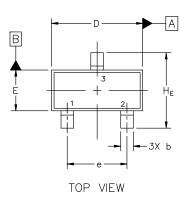
ORDERING INFORMATION

| Device Order Number | Package Type | Shipping [†] |
|---------------------|---------------------|-----------------------|
| MMBTA55LT1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |
| MMBTA55LT3G | SOT-23 (Pb-Free) | 10,000 / Tape & Reel |
| MMBTA56LT1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |
| SMMBTA56LT1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |
| MMBTA56LT3G | SOT-23 (Pb-Free) | 10,000 / Tape & Reel |
| SMMBTA56LT3G | SOT-23 (Pb-Free) | 10,000 / Tape & Reel |

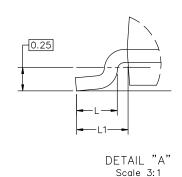
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

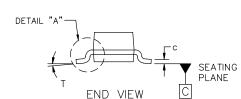
PACKAGE DIMENSIONS

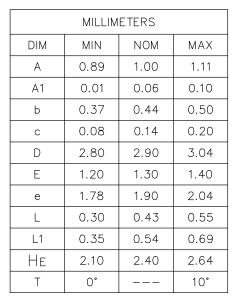
SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318 ISSUE AU**



SIDE VIEW



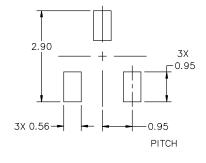




NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS:
- MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

STYLE 6: PIN 1. BASE **EMITTER** COLLECTOR



RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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